D52 ANT SoC Module Series

Module Hardware
- Integrated printed antenna
- On-board 32MHz and 32.768 kHz crystal clocks
- 1.7V - 3.6V supply (D52QD2M4IA, D52MD2M8IA, D52QPMM4IA, D52MPMM8IA)
- 1.71V - 3.6V supply (D52QD2M4IA-A, D52QPMM4IA-A)
- Operating temperature: Industrial (-40°C to +85°C)
- Up to 30 GPIOs (D52QD2M4IA, D52QPMM4IA)
- Up to 24 GPIOs (D52QD2M4IA-A, D52MD2M8IA, D52QPMM4IA-A, D52MPMM8IA-A)
- Programmable output/channel from -20dBm to 4dBm
- Excellent receiver sensitivity
  -93dBm (ANT mode)
  -96dBm (BLE mode)
- 1dBm resolution RSSI
- Total 512kB flash, 64kB RAM
- SPI, I2C and UART interface
- ARM SWD interface
- Internal DC/DC converter supported
- 20 x 20mm module (D52Q models, M4 format)
- 14 x 9.8 x 2.0mm module (D52M models, M8 format)
- Onboard 3-axis MEMS accelerometer (D52QD2M4IA-A, D52QPMM4IA-A)
  - LIS2DH by ST Microelectronics
  - 2 programmable interrupt pins
- Layout compatible options with N5150M4CD, N550M4CC, N548M4CB, ANTAP281M4IB, ANTCT82M4IB (for D52Q models)¹
- Layout compatible options with N5150M8CD, N550M8CC, N548M8CB (for D52M models)¹
- Radio regulatory approval for major markets
- BLUETOOTH SIG qualification
- RoHS compliant

Series Members:
- D52QD2M4IA, D52QD2M4IA-A, D52QD2M6IA-A, D52MD2M8IA, D52QPMM4IA, D52QPMM4IA-A, D52MPMM8IA, D52QSKM6IA-A

All models are preloaded with ANT Network Processor application.

ANT® Operation (using the latest s212 or s332 SoftDevice)
- 79 selectable RF channels (2402 to 2480 MHz)
- Flexible network topologies: peer-to-peer, star, tree, high node count, mesh and more
- Broadcast, acknowledged, and burst data communication modes
- Built-in device search and pairing
- Built-in interference handling and radio coexistence management with application radio disable requests and application flash write/erase requests
- Enhanced ANT features:
  - Supports up to 15 logical channels each with configurable channel periods (5.2ms - 2s)
  - Advanced burst data transfer modes (up to 60kbps)
  - Optional channel encryption mode (aes-128)
  - Supports up to 8 public, private and/or managed networks
  - Advanced power management features to optimize application power consumption including Event Filtering and Selective Data Updates
  - Asynchronous transmit channel
  - Fast channel initiation
  - High duty search

Bluetooth® low energy operation (when loaded with the latest S132 or S332 SoftDevice)
- Bluetooth 4.2 compliant low energy single-mode protocol stack suitable for Bluetooth low energy products
  - Concurrent Central, Observer, Peripheral, and Broadcaster roles with:
    - Multiple connections as a central
    - One connection as a peripheral
    - Observer
    - Broadcaster
  - Link layer
  - L2CAP, ATT, and SM protocols
  - GATT and GAP APIs
  - GATT Client and Server

¹ In certain configurations; see section 2.3 - Pin-outs - for complete details
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Notices and Restricted Use Information

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The Modules are not designed, intended, or authorized for use as components in systems intended for surgical implant into the body, or other applications intended to support or sustain life, or for any other application in which the failure of the Module could create a situation where personal injury or death may occur. If you use the Modules for such unintended and unauthorized applications, you do so at your own risk and you shall indemnify and hold GARMIN and its officers, employees, subsidiaries, affiliates, and distributors harmless against all claims, costs, damages, and expenses, and reasonable attorney fees arising out of, directly or indirectly, any claim of personal injury or death associated with such unintended or unauthorized use, even if such claim alleges that GARMIN was negligent regarding the design or manufacture of the Product.

D52 Modules have been designed to operate in typical operating environments up to 30m.

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GARMIN believes the information contained herein is correct and accurate at the time of its release. However, the information contained in this document is subject to change without notice and should not be construed as a commitment by GARMIN unless such commitment is expressly given in a covering document.

The D52 Series of modules have been designed to support the ANT and/or Bluetooth low energy Protocols and are certified for use in many geographic regions around the globe. However, a product incorporating the D52 series module may carry the certification IDs of the module only if it complies with the restrictions and terms, including use of GARMIN approved software, provided in the conditions of use available at:

https://www.thisisant.com/developer/components/d52/#879_tab

2 Typical operating environment: commercial IoT use case, less than 5% message packet loss rate.
One Year Limited Warranty

This D52 Module is warranted to be free from defects in materials or workmanship for 1 year from the date of purchase by the end customer. Within this period, Garmin will, at its sole option, replace any D52 Modules that fail in normal use. Replaced D52 Modules have a 1 year warranty. Garmin retains the exclusive right to replace (with a new or newly-overhauled replacement product) the D52 Module or offer a full refund of the purchase price at its sole discretion. SUCH REMEDY SHALL BE THE SOLE AND EXCLUSIVE REMEDY FOR ANY BREACH OF WARRANTY. Such replacement will be made at no charge to LICENSEE, provided LICENSEE shall be responsible for any transportation cost. This warranty does not apply to: (i) cosmetic damage, such as scratches, nicks and dents; (ii) damage caused by accident, abuse, misuse, water, flood, fire, or other acts of nature or external causes; (iii) damage caused by service performed by anyone who is not an authorized service provider of Garmin or (iv) damage to a D52 Module that has been modified or altered without the written permission of Garmin. In addition, Garmin reserves the right to refuse warranty claims against D52 Modules used in contravention of the laws of any country.

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IN NO EVENT SHALL D GARMIN BE LIABLE FOR ANY INCIDENTAL, SPECIAL, INDIRECT, OR CONSEQUENTIAL DAMAGES, WHETHER RESULTING FROM THE USE, MISUSE, OR INABILITY TO USE THIS PRODUCT OR FROM DEFECTS IN THE PRODUCT.

To obtain warranty service, LICENSEE shall contact Garmin for shipping instructions and obtain a return material authorization (RMA) tracking number. LICENSEE shall securely pack the D52 Modules and enclose a copy of the original sales receipt, which is required as the proof of purchase for a warranty claim, and write the tracking number clearly on the outside of the package. LICENSEE agrees to send the D52 Modules, freight charges prepaid, to the Garmin address provided in the Module Distribution Agreement (see https://www.thisisant.com/developer/components/d52/#879_tab).

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1  D52 ANT SoC Module Series Overview

Garmin offers the [D52 series of ANT SoC Modules](https://www.thisisant.com), based on Nordic Semiconductor's nRF52832 SoC supporting ANT, Bluetooth® low energy technology and extended features such as NFC. This expands Garmin portfolio of multi-protocol ultra-low power wireless modules, including the [N5 series](https://www.thisisant.com). Features of the D52 series include:

- Nordic Semiconductor's nRF52832 chip with 64kB RAM, 512kB Flash and a 32-bit ARM Cortex M4F CPU
- Concurrent ANT and Bluetooth protocol operation using supported SoftDevices (pre-compiled protocol stack solutions for the nRF52 SoCs):
  - S212 – ANT only SoftDevice from Garmin
  - S332 – concurrent ANT and Bluetooth low energy SoftDevice from Garmin
  - S132 – Bluetooth low energy only SoftDevice from Nordic Semiconductor
- Certification of compliance with regulation standards in major markets including North America, Australia / New Zealand, Japan and Korea. Declared conformity with radio regulations and requirements for Europe.
- Qualification by the Bluetooth SIG
- Onboard 32MHz and 32.768kHz crystal clocks
- The preloaded Network Processor application provides a standard ANT serial interface that can be connected to an existing external application controller without reprogramming the module. The application uses the S212 SoftDevice (scalable ANT protocol stack with 15 channel support).
- Easy reprogramming via the onboard SWD interface pins using off-the-shelf ARM programming tools
- D52Q models support drop-in compatibility with Garmin (Dynastream) ANTC782M4IB, ANTAP281M4IB, N5150M4CD, N550M4CC and N548M4CB modules (in certain configurations).
- D52M models support drop-in compatibility with Garmin (Dynastream) N5150M8CD, N550M8CC, N548M8CB modules (in certain configurations).

The D52 ANT SoC module series includes the following models, all covered in this data sheet:

<table>
<thead>
<tr>
<th>Part no.</th>
<th>ANT Libraries Support</th>
<th>Description</th>
</tr>
</thead>
<tbody>
<tr>
<td>D52QD2M4IA</td>
<td>SoftDevice only</td>
<td>20 x 20mm module with up to 30GPIOs and 8 analog inputs</td>
</tr>
<tr>
<td>D52QPM4IA</td>
<td>High Node Count libraries</td>
<td></td>
</tr>
<tr>
<td>D52QD2M4IA-A</td>
<td>SoftDevice only</td>
<td>20 x 20mm module with up to 24GPIOs and 5 analog inputs; onboard 3-axis MEMS accelerometer</td>
</tr>
<tr>
<td>D52QPM4IA-A</td>
<td>High Node Count libraries</td>
<td></td>
</tr>
<tr>
<td>D52MD2M8IA</td>
<td>SoftDevice only</td>
<td>14.0 x 9.8 x 2.0mm module with up to 24GPIOs and 8 analog inputs</td>
</tr>
<tr>
<td>D52MPM8IA</td>
<td>High Node Count libraries</td>
<td></td>
</tr>
<tr>
<td>D52QD2M6IA-A</td>
<td>SoftDevice only</td>
<td>A D52 M4 form factor module with accelerometer mounted on a carrier board for development use</td>
</tr>
<tr>
<td>D52QSKM6IA-A</td>
<td>High Node Count, G.FIT® development</td>
<td></td>
</tr>
</tbody>
</table>

Table 1: D52 ANT SoC Module Series Models

The [D52 series development kit](https://www.thisisant.com/developer/components/d52series/) (D52DK2) contains everything necessary to evaluate and begin development with D52 series modules, with support for the Nordic nRF5 SDK. An additional extension kit (D52EXT1) is also available and is useful for high node count network exploration and development.

---

3 Please see section 3 of this data sheet for details about leveraging D52 certification.
4 Layouts are compatible with D52Q when using the reset pin only; the nRF52832 supports separate reset and SWDIO lines rather than the single shared line from previous Nordic SoCs. See section 2.3 for more information.
5 Layouts are compatible with D52M when using the SWDIO pin only; the nRF52832 supports separate reset and SWDIO lines rather than the single shared line from previous Nordic SoCs. See section 2.3 for more information.
6 For more information about G.FIT Fitness Equipment Modules, visit [https://www.thisisant.com/developer/components/gfit/](https://www.thisisant.com/developer/components/gfit/)
1.1 Nomenclature

Example: D52M D2 M8 I A

Module Family Name
- D52 = Dynastream module using Nordic nRF52
- Q = Module uses Nordic QFN package
- M = Module uses Nordic CSP package

Feature Set / SW Load
- D2 = ANT Network Processor App
- PM = Premium ANT Library support
- SK = Starter Kit support for all ANT libraries/applications

Size/Type
- M4 = 20x20 mm with PCB edge pads, (LGA on base)
- M6 = M4 module on dev kit carrier board (not for use in shipping products)
- M8 = 14.0 x 9.8 x 2.0mm LGA module

Temperature Range
- I = Industrial, -40 to +85°C

Hardware Revision
- A = onboard accelerometer included

1.2 Production Tracking Code

For technical support and customer service purposes, a production code of three characters of the format “YWR” is laser marked on the RF shield as illustrated below. In the code, YW (“6V” and “6K” in Figure 2, below) denotes production date code and R (“B” and “2” in Figure 2, below) denotes module version.

Please refer to Appendix B – D52 Module Series Pre-Loaded Software Versions for differences and important notes of each version.
### 1.3 Models

This section details some basic information about orderable SKUs for models in the D52 ANT SoC Module Series.

<table>
<thead>
<tr>
<th>Module</th>
<th>Part No.</th>
<th>Description</th>
<th>Ordering/Package Information</th>
<th>Part Status</th>
</tr>
</thead>
</table>
| D52QD2M4IA              | D52QD2M4IA-A | 20 x 20mm module with up to 24GPIOs and 5 analog inputs; onboard 3-axis MEMS accelerometer | • D52QD2M4IA-A-TRAY: 20pc in 4x5 tray  
• D52QD2M4IA-A-REEL: 800pc on 13” tape and reel                                                  | Active      |
| D52QPM4IA               | D52QPM4IA-A  | Additional support for advanced ANT libraries (e.g., High Node Count networks)               | • D52QPM4IA-A-TRAY: 20pc in 4x5 tray  
• D52QPM4IA-A-REEL: 800pc on 13” tape and reel                                                   | Active      |
| D52QD2M4IA              | D52QD2M4IA   | 20 x 20mm module with up to 30GPIOs and 8 analog inputs                                        | • D52QD2M4IA-TRAY: 20pc in 4x5 tray  
• D52QD2M4IA-REEL: 800pc on 13” tape and reel                                                    | Active      |
| D52QPM4IA               | D52QPM4IA    | Additional support for advanced ANT libraries (e.g., High Node Count networks)               | • D52QPM4IA-TRAY: 20pc in 4x5 tray  
• D52QPM4IA-REEL: 800pc on 13” tape and reel                                                   | Active      |
| D52MD2M8IA              | D52MD2M8IA   | 14.0 x 9.8 x 2.0mm module with up to 24GPIOs and 8 analog inputs                             | • D52MD2M8IA-TRAY: 40pc in 8x5 tray  
• D52MD2M8IA-REEL: 1500pc on 13” tape and reel                                                  | Active      |
| D52MPMM8IA              | D52MPMM8IA   | Additional support for advanced ANT libraries (e.g., High Node Count networks)               | • D52MPMM8IA-TRAY: 40pc in 8x5 tray  
• D52MPMM8IA-REEL: 1500pc on 13” tape and reel                                                  | Active      |
| D52QD2M6IA              | D52QD2M6IA-A | D52QD2M4IA-A mounted on a carrier board for starter kit and development use                  | • D52QD2M6IA-TRAY: 10 pc on 150x165mm tray                                                    | Active      |
| D52SKM6IA-A             | D52SKM6IA-A  | Supports development on ALL ANT applications (including High Node Count Networks and G.FIT) | • D52SKM6IA-A-TRAY: 10 pc on 150x165mm tray                                                  | Active      |

Table 2: D52 ANT SoC Module Series Models

* ACTIVE: Device, tool, or software recommended for new designs.

For more information about G.FIT Fitness Equipment Modules, visit [https://www.thisisant.com/developer/components/gfit/](https://www.thisisant.com/developer/components/gfit/)
1.4 D52 ANT SoC Module Starter Kit and Components

The D52 starter kit (D52DK2) contains all the hardware necessary to get developing with ANT, including advanced ANT libraries (e.g., ANT BLAZE™) and G.FIT™. The downloadable ANT SoC Module Starter Kit User Manual describes using the kit with reference examples and the nRF5 SDK from Nordic Semiconductor. The kit is outlined in Table 3, below:

<table>
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<tr>
<th>D52 Starter Kit</th>
<th>Description</th>
<th>Quantity</th>
<th>Picture</th>
</tr>
</thead>
<tbody>
<tr>
<td>D52QSKM6IA-A</td>
<td>M4 module on carrier board with 20-pin Molex connector, NFC connections available, SWD programming header, additional through-hole connections for I/O pins</td>
<td>2</td>
<td><img src="https://example.com" alt="Image" /></td>
</tr>
<tr>
<td>ANTBAT2</td>
<td>Battery board with a Molex socket, a reset button and a five-position dip switch</td>
<td>2</td>
<td><img src="https://example.com" alt="Image" /></td>
</tr>
<tr>
<td>ANTIO1</td>
<td>I/O board with a Molex connector, a Molex socket, 4 LEDs and 4 buttons</td>
<td>2</td>
<td><img src="https://example.com" alt="Image" /></td>
</tr>
<tr>
<td>ANTIUF1</td>
<td>USB interface board with a Molex socket</td>
<td>1</td>
<td><img src="https://example.com" alt="Image" /></td>
</tr>
<tr>
<td>ANTIUSB-m</td>
<td>ANT USB dongle</td>
<td>1</td>
<td><img src="https://example.com" alt="Image" /></td>
</tr>
<tr>
<td>Segger J-Link Lite Programmer</td>
<td></td>
<td>1</td>
<td><img src="https://example.com" alt="Image" /></td>
</tr>
</tbody>
</table>

Table 3: D52 ANT SoC Module Starter Kit
1.5 D52 ANT SoC Module Extender Kit and Components

The D52 extender kit (D52EXT1) builds on the D52 starter kit to provide extra nodes and more power for IoT developers and platforms, including ANT BLAZE™. This kit also includes the ANTBAT3 combination I/O and battery board. Powered by 2 AA batteries, the development board enables longer testing and development and includes buttons and LEDs for testing input and interaction. A D52 starter kit (D52DK2) is recommended for use with the extender kit, as the starter kit includes the tools necessary to program and monitor development nodes.

<table>
<thead>
<tr>
<th>D52 Extender Kit</th>
<th>Description</th>
<th>Quantity</th>
<th>Picture</th>
</tr>
</thead>
<tbody>
<tr>
<td>D52QSKM61A-A</td>
<td>M4 module on carrier board with 20-pin Molex connector, NFC connections available, SWD programming header, additional through-hole connections for I/O pins</td>
<td>4</td>
<td><img src="image.png" alt="Image" /></td>
</tr>
<tr>
<td>ANTBAT3</td>
<td>Combined battery and I/O board with a Molex socket, a reset button, I/O buttons, LEDs and dip switches, powered by two AA batteries</td>
<td>4</td>
<td><img src="image.png" alt="Image" /></td>
</tr>
</tbody>
</table>

Table 4: D52 ANT SoC Module Extender Kit
2 Product Overview

2.1 D52Q Model Block Diagrams

Figure 3: D52QD2M4IA-A, D52QPMM4IA-A Models (with accelerometer) Module Block Diagram

Figure 4: D52QD2M4IA, D52QPMM4IA Models (no accelerometer) Module Block Diagram
2.2 D52M Model Block Diagram

![Block Diagram](image)

Figure 5: D52MD2M8IA, D52MPMM8IA Models Module Block Diagram

2.3 Pin-outs

**A note on backwards drop-in compatibility with D52Q:** D52Q M4 modules support drop-in compatibility with ANTAP281M4IB, ANTC782M4IB, N5150M4CD, N550M4CC and N548M4CB modules from Garmin (formerly Dynastream) under certain configurations. For drop-in compatibility, existing designs must use only the reset capability of the reset/SWDIO pin on previous modules. See pin H202, below. In addition, there must be nothing on existing designs that would contact the new-to-layout LGA pads in the middle of the D52Q modules.

**A note on backwards drop-in compatibility:** the D52M modules support drop-in compatibility with the following N5 M8 module models from Garmin (formerly Dynastream) in certain configurations: N5150M8CD, N550M8CC, N548M8CB. For drop-in compatibility, existing designs must use only the SWDIO capability of the reset/SWDIO pad on previous modules. If needed, the reset function can be configured on another pad; see Table 5 below for more information.

**A note on the preloaded Network Processor application:** Please refer to Appendix A – Using the ANT Network Processor Configuration for ANT Serial Line specification.
Figure 6: D52Q M4 (20mm x 20mm) Bottom View

Figure 7: D52M M8 (14.0mm x 9.8mm) Bottom View
Figure 8: D52Q M6 (Development Module) - Top View

Figure 9: D52Q M6 (Development Module) - Bottom View
<table>
<thead>
<tr>
<th>D52Q M4 Pin</th>
<th>D52M M8 Pin</th>
<th>Molex Connector</th>
<th>Dev Board Pin</th>
<th>nRF52832 Pin Name</th>
<th>Description</th>
</tr>
</thead>
<tbody>
<tr>
<td>H201</td>
<td>P230</td>
<td>16</td>
<td>J102.19</td>
<td>SWDIO</td>
<td>Serial Wire Debug I/O for debug and programming</td>
</tr>
<tr>
<td>H202</td>
<td>P207</td>
<td>10</td>
<td>J101.06</td>
<td>P021/RESET</td>
<td>General Purpose I/O / System Reset pin</td>
</tr>
<tr>
<td>H203</td>
<td>P225, P226, P219, P220</td>
<td>1</td>
<td>J101.01</td>
<td>VCC</td>
<td>Power Supply Pin</td>
</tr>
<tr>
<td>H204</td>
<td>P231, P232, P233, P234, P235</td>
<td>19</td>
<td>J101.02, J101.08, J102.20</td>
<td>VSS</td>
<td>Ground</td>
</tr>
<tr>
<td>H205</td>
<td>P224</td>
<td>6</td>
<td>J101.07</td>
<td>SWDCLK</td>
<td>Serial Wire Debug clock input for debug and programming</td>
</tr>
<tr>
<td>H206</td>
<td>P212</td>
<td>17</td>
<td>J101.09</td>
<td>P006</td>
<td>General Purpose I/O</td>
</tr>
<tr>
<td>H207</td>
<td>-</td>
<td>15</td>
<td>J101.10</td>
<td>P007</td>
<td>General Purpose I/O</td>
</tr>
<tr>
<td>H208</td>
<td>P208</td>
<td>-</td>
<td>J102.01</td>
<td>P002/AIN0</td>
<td>General Purpose I/O / Analog SAADC/COMP/LPCOMP input</td>
</tr>
<tr>
<td>H209</td>
<td>P218</td>
<td>11</td>
<td>J101.17</td>
<td>P008</td>
<td>General Purpose I/O</td>
</tr>
<tr>
<td>H210</td>
<td>P201</td>
<td>7</td>
<td>J101.19</td>
<td>P011</td>
<td>General Purpose I/O</td>
</tr>
<tr>
<td>H211</td>
<td>-</td>
<td>4</td>
<td>J101.04, J101.15</td>
<td>P017</td>
<td>General Purpose I/O</td>
</tr>
<tr>
<td>H212</td>
<td>P221</td>
<td>3</td>
<td>J101.03, J101.11</td>
<td>P016</td>
<td>General Purpose I/O</td>
</tr>
<tr>
<td>H213</td>
<td>P228</td>
<td>5</td>
<td>J101.18</td>
<td>P015</td>
<td>General Purpose I/O</td>
</tr>
<tr>
<td>H214</td>
<td>P217</td>
<td>9</td>
<td>J101.20</td>
<td>P014</td>
<td>General Purpose I/O</td>
</tr>
<tr>
<td>H215</td>
<td>P216</td>
<td>-</td>
<td>J102.17</td>
<td>P013</td>
<td>General Purpose I/O</td>
</tr>
<tr>
<td>H216</td>
<td>P205</td>
<td>8</td>
<td>J102.15</td>
<td>P031/AIN0</td>
<td>General Purpose I/O / Analog SAADC/COMP/LPCOMP input</td>
</tr>
<tr>
<td>H217</td>
<td>P229</td>
<td>2</td>
<td>J101.05</td>
<td>P012</td>
<td>General Purpose I/O</td>
</tr>
<tr>
<td>P201</td>
<td>P222</td>
<td>-</td>
<td>NFC2</td>
<td>NFC2/P010</td>
<td>NFC antenna connection / General Purpose I/O</td>
</tr>
<tr>
<td>P202</td>
<td>-</td>
<td>14</td>
<td>J102.04</td>
<td>P019</td>
<td>General Purpose I/O</td>
</tr>
<tr>
<td>P203</td>
<td>P227</td>
<td>13</td>
<td>J102.06</td>
<td>P020</td>
<td>General Purpose I/O</td>
</tr>
<tr>
<td>P204</td>
<td>P215</td>
<td>18</td>
<td>J102.08</td>
<td>P022</td>
<td>General Purpose I/O</td>
</tr>
<tr>
<td>P205</td>
<td>-</td>
<td>20</td>
<td>J102.10</td>
<td>P023</td>
<td>General Purpose I/O</td>
</tr>
<tr>
<td>P206</td>
<td>P223</td>
<td>-</td>
<td>NFC1</td>
<td>NFC1/P009</td>
<td>NFC antenna connection / General Purpose I/O</td>
</tr>
<tr>
<td>P207</td>
<td>P211</td>
<td>-</td>
<td>J102.07</td>
<td>P005/AIN3</td>
<td>General Purpose I/O / Analog SAADC/COMP/LPCOMP input</td>
</tr>
<tr>
<td>P208</td>
<td>P214</td>
<td>-</td>
<td>J102.02</td>
<td>P018</td>
<td>General Purpose I/O</td>
</tr>
<tr>
<td>P209</td>
<td>P213</td>
<td>12</td>
<td>J102.12</td>
<td>P024</td>
<td>General Purpose I/O</td>
</tr>
<tr>
<td>P210</td>
<td>P209</td>
<td>-</td>
<td>J102.05</td>
<td>P004/AIN2</td>
<td>General Purpose I/O / Analog SAADC/COMP/LPCOMP input</td>
</tr>
<tr>
<td>P211</td>
<td>P210</td>
<td>-</td>
<td>J102.03</td>
<td>P003/AIN1</td>
<td>General Purpose I/O / Analog SAADC/COMP/LPCOMP input</td>
</tr>
<tr>
<td>P212*</td>
<td>-</td>
<td>-</td>
<td>J102.16</td>
<td>P026</td>
<td>General Purpose I/O</td>
</tr>
<tr>
<td>P213*</td>
<td>P203</td>
<td>-</td>
<td>J102.11</td>
<td>P029/AIN5</td>
<td>General Purpose I/O / Analog SAADC/COMP/LPCOMP input</td>
</tr>
<tr>
<td>P214*</td>
<td>P204</td>
<td>-</td>
<td>J102.13</td>
<td>P030/AIN6</td>
<td>General Purpose I/O / Analog SAADC/COMP/LPCOMP input</td>
</tr>
<tr>
<td>P215*</td>
<td>P202</td>
<td>-</td>
<td>J102.09</td>
<td>P028/AIN4</td>
<td>General Purpose I/O / Analog SAADC/COMP/LPCOMP input</td>
</tr>
<tr>
<td>P216*</td>
<td>-</td>
<td>-</td>
<td>J102.18</td>
<td>P027</td>
<td>General Purpose I/O</td>
</tr>
<tr>
<td>P217*</td>
<td>P206</td>
<td>-</td>
<td>J102.14</td>
<td>P025</td>
<td>General Purpose I/O</td>
</tr>
</tbody>
</table>

Table 5: D52 Module Series Pin-Out

\* See section 2.3.1 for onboard accelerometer pin usage (optional; D52Q models with -A suffix only).
2.3.1 (Optional) Accelerometer Specification

The D52 module series includes an accelerometer accessory on the D52QD2M4IA-A, D52QPMM4IA-A models, only. The accelerometer is the LIS2DH by STMicroelectronics. To make use of the accelerometer, the following pins are consumed:

<table>
<thead>
<tr>
<th>D52QD2M4IA-A Pin</th>
<th>nRF52832 Pin</th>
<th>LISD2H Pin</th>
</tr>
</thead>
<tbody>
<tr>
<td>P212</td>
<td>P026</td>
<td>INT2</td>
</tr>
<tr>
<td>P213</td>
<td>P029/AIN5</td>
<td>SDA/SDI/SDO</td>
</tr>
<tr>
<td>P214</td>
<td>P030/AIN6</td>
<td>SCL/SPC</td>
</tr>
<tr>
<td>P215</td>
<td>P028/AIN4</td>
<td>SDO/SA0</td>
</tr>
<tr>
<td>P216</td>
<td>P027</td>
<td>CS</td>
</tr>
<tr>
<td>P217</td>
<td>P025</td>
<td>INT1</td>
</tr>
</tbody>
</table>

Table 6: Accelerometer Pin Assignment

SPI or I²C can be used to communicate with the accelerometer. To use I²C, pull-up resistors will need to be added to the appropriate pads.

For more information about D52Q pin assignments, refer to Table 5: D52 Module Series Pin-Out.

For more information about this component including data sheet and errata, please refer to the STMicroelectronics website:


2.4 Preloaded Software

D52 series modules are preloaded with the S212 ANT SoftDevice and the ANT Network Processor (NP) application as illustrated below. Depending on the module revision, the preloaded code may vary. Please refer to Appendix B – D52 Module Series Pre-Loaded Software Versions for further details. Licensing terms for the preloaded software are described in the Module Distribution Agreement, which is referenced in section 4 - Licensing & Conditions of Use.

- **S212 SoftDevice** – Refer to the S212 nRF52832 SoftDevice Specification.
- **ANT Network Processor Application** – Refer to Appendix A – Using the ANT Network Processor Configuration

![Figure 10: Memory Map of the Preloaded Software](image-url)
2.5 D52 Module Programming

The D52 ANT SoC module series supports programming by standard Serial Wire Debug (SWD) interface. The two software components (the SoftDevice and the application code) must be version compatible to operate properly. To ensure proper operation after reprogramming, it is recommended that the module undergoes a full erasure (e.g. using the erase-all option in nrfjprog.exe/nRFgo Studio) and all desired software components be explicitly programmed onto the module.

2.5.1 Programming via SWD Interface

The D52 ANT SoC Module series supports the Serial Wire Debug (SWD) interface, SWDCLK and SWDIO (refer to Table 5: D52 Module Series Pin-Out). Programming and debugging of the module only require commonly available tools, such as the Keil software development environment and the Segger J-Link programmer.

Please refer to "ANT SoC Module Starter Kit User Manual" from Garmin (formerly Dynastream Innovations) for reference software setup and use with ANT using the Keil software and a J-Link programmer.

2.5.2 Initializing the SoftDevice

D52 series modules come with 20ppm onboard 32 kHz crystals. When initializing the SoftDevice, it is important to set the crystal accuracy to be 20ppm. This clock source is selected when enabling the SoftDevice via the `sd_softdevice_enable` command.

2.5.3 Configuring the DC/DC converter

D52 series modules can make use of the DC/DC Converter on nRF52832 chips. This can improve power consumption under certain conditions.

2.6 Design Considerations

RF performance is always affected by the environment. Good design makes a product less susceptible to adverse conditions. The recommendations in this section are guidelines only; you should thoroughly test your products in the intended use case environments and make necessary modifications and trade-offs.

For assistance in design, a STEP model package and Altium library are available from Garmin (formerly Dynastream Innovations) for all D52 module series models.

2.6.1 D52Q M6 module mounting

The mating socket is Molex 52991-0208.

2.6.2 D52Q M4 Module Mounting

Figure 11 shows D52Q component outline and keepout areas in pink. There should not be any exposed copper or routing in the keepout areas, on any layer. The component body is crosshatched pink, and signal pads are red. Please reference the D52Q Altium Footprint for more accurate keepout dimensions and positioning. Figure 12, on the next page, describes mating PCB characteristics.

![Figure 11: D52Q signal pads, component outline and keepout areas](Image)
Figure 12: DS2Q Module Mounting
2.6.3 D52M M8 Module Mounting

Figure 13: D52M Module Mounting

Legend:
- RF Keepout
- Copper & Component
- Mounting PCB

Copper or component material should be kept at least 0.10" from the module edges. The RF keepout region is free space where best RF performance is achieved when the RF component is not present.
Figure 14, below, shows D52M component outline and keepout areas in pink. There should not be any exposed copper or routing in the keepout areas, on any layer. The component body is crosshatched pink, and signal pads are shown in red. Please reference the D52M Altium Footprint for more accurate keepout dimensions and positioning. Figure 13, on the previous page, describes mating PCB characteristics.

Figure 14: D52M signal pads, component outline and keepout areas

2.7 Assembly Considerations

2.7.1 Moisture Control

D52 series modules are rated at different levels as defined by IPC/JEDEC J-STD-020:

<table>
<thead>
<tr>
<th>D52 Model</th>
<th>Moisture Control Level</th>
</tr>
</thead>
<tbody>
<tr>
<td>D52QD2M4IA-A, D52QPMM4IA-A</td>
<td>3</td>
</tr>
<tr>
<td>D52QD2M4IA, D52QPMM4IA</td>
<td>2</td>
</tr>
<tr>
<td>D52MD2M8IA, D52MPMM8IA</td>
<td>1</td>
</tr>
</tbody>
</table>

Table 7: D52 Module Series Moisture Control Levels

To ensure good solderability of the PCB pads, it is highly recommended to always have the modules intended for reflow well sealed when in storage.
2.7.2 **D52Q M4 Module Solder Stencil**

The following reference example is used to create the D52QD2M6IA-A development modules:

![Figure 15: D52Q M4 Solder Stencil](image)

2.7.3 **D52M M8 Module Solder Stencil**

Below is a diagram describing a solder stencil for Garmin (formerly Dynastream) M8 modules, including the D52M:

![Figure 16: D52M M8 Solder Stencil](image)

- Circle Pad (white): 30mil
- Square Aperture (red): 14.5mil

2.7.4 **Cleaning Process**

D52 series modules are made using no-clean solder paste. No-clean process is recommended.
3 Regulatory Approvals and Compliance

Modules in the D52 ANT SoC Module Series, when loaded with an ANT and/or BLUETOOTH low energy stack\(^9\), have received regulatory approvals in the United States (FCC) and Canada (IC), and have been verified to conform to the appropriate regulations in Europe, Australia and New Zealand, Japan and South Korea. The modules have been qualified by BLUETOOTH SIG. Such approvals and qualification allow the user to place the module inside a finished product and, in most cases, not require regulatory testing for an intentional radiator, provided no changes or modifications are made to the module circuitry. This does not preclude the possibility that some other form of authorization or testing may be required for the finished product.

Changes or modifications could void the user's authority to operate the equipment. The end user must comply with all of the instructions provided by the Grantee, which indicate installation and/or operating conditions necessary for compliance.

3.1 United States

This device complies with part 15 of the FCC Rules. Operation is subject to the following two conditions: (1) This device may not cause harmful interference, and (2) this device must accept any interference received, including interference that may cause undesired operation.

A host product manufacturer is responsible for ensuring compliance with the module(s) installed and fully operational. For example, if a host product was previously authorized as an unintentional radiator under the Declaration of Conformity procedure without containing a certified transmitter module, then a module is added, the host manufacturer is responsible for ensuring that the host continues to be compliant with the Part 15 subpart B unintentional radiator requirements after the module is installed and operational. Because this may depend on the details of how the module is integrated within the host, the module grantee (the party responsible for the module grant) shall provide guidance to the host manufacturer for ensuring compliance with the Part 15 Subpart B requirements.

This module is limited to OEM installation ONLY. The OEM Integrator is responsible for ensuring that the end-user has no manual instructions to remove or install the module. Changes or modifications not expressly approved by Garmin could void the user's authority to operate the equipment.

If (1) the module’s FCC ID is not visible when installed in the host, or (2) if the host is marketed so that end users do not have straightforward commonly used methods for access to remove the module so that the FCC ID of the module is visible; then an additional permanent label referring to the enclosed module must be used:

- For D52Q modules: "Contains Transmitter Module FCC ID: 06R3067” or "Contains FCC ID: 06R3067”
- For D52M modules: "Contains Transmitter Module FCC ID: 06R3153” or "Contains FCC ID: 06R3153”

The host OEM user manual must also contain clear instructions on how end users can find and/or access the module and the FCC ID.

3.2 Canada

This device complies with Industry Canada's license-exempt RSSs. Operation is subject to the following two conditions:

(1) This device may not cause interference; and

(2) This device must accept any interference, including interference that may cause undesired operation of the device.

Le présent appareil est conforme aux CNR d'Industrie Canada applicables aux appareils radio exempts de licence. L'exploitation est autorisée aux deux conditions suivantes : (1) l'appareil ne doit pas produire de brouillage, et (2) l'utilisateur de l'appareil doit accepter tout brouillage radioélectrique subi, même si le brouillage est susceptible d'en compromettre le fonctionnement.

\(^9\) Refer to section 4
To comply with Industry Canada regulations, it is required that products containing the D52 module series display a label referring to the enclosed module. This exterior label can use wording similar to the following:

- For **D52Q** modules: “Contains IC: 3797A-3067”
- For **D52M** modules: “Contains IC: 3797A-3153”

This information shall be affixed in such a manner as not to be removable except by destruction or defacement. The size of the lettering shall be legible without the aid of magnification but is not required to be larger than 8-point font size. If the device is too small to meet this condition, the information can be included in the user manual upon agreement with Industry Canada.

### 3.3 European Economic Area

D52 series modules are declared to be in conformance with the essential requirements and other relevant provisions of Directive 2014/53/EU and 2011/65/EU, as a low-powered unlicensed transmitter:


- **EN 62479:2010**  
  Information technology equipment – Safety – Part 1: General requirements

- **EN 300 328 v2.1.1 2016-11**  
  Assessment of the compliance of low power electronic and electrical equipment with the basic restrictions related to human exposure to electromagnetic fields (10 MHz to 300 GHz)

- **EN 300 440 v2.1.1 2017-03**  
  Short Range Devices (SRD); Radio equipment to be used in the 1 GHz to 40 GHz frequency range

- **EN 301 489-1 v2.1.1 2017-02**  
  ElectroMagnetic Compatibility (EMC) standard for radio equipment and services; Part 1: Common technical requirements; Part 3: Specific conditions for Short-Range Devices (SRD) operating on frequencies between 9 kHz and 246 GHz; Part 17: Specific conditions for Broadband Data Transmission Systems
3.4 Australia and New Zealand
The D52 ANT SoC module series has been tested and found to comply with:

<table>
<thead>
<tr>
<th>Standard</th>
<th>Description</th>
</tr>
</thead>
<tbody>
<tr>
<td>ACMA Radiocommunications (Short Range Devices) Standards 2014; 2400 and 5700 MHz bands only</td>
<td></td>
</tr>
<tr>
<td>EN 60950-1: (2nd Edition) Information technology equipment. Safety. General requirements</td>
<td></td>
</tr>
<tr>
<td>AS/NZS CISPR 22:2009 Information technology equipment. Radio disturbance characteristics. Limits and methods of measurement</td>
<td></td>
</tr>
<tr>
<td>AS/NZS 4268:2012 – Radio equipment and systems – Short Range Devices – Limits and methods of measurement</td>
<td></td>
</tr>
<tr>
<td>EN 301 489-1/-3/-17 Electromagnetic compatibility and Radio spectrum Matters (ERM); ElectroMagneitic Compatibility (EMC) standard for radio equipment and services; Part 1: Common technical requirements ; Part 3: Specific conditions for Short-Range Devices (SRD); Part 17: Specific conditions for Broadband Data Transmission systems</td>
<td></td>
</tr>
<tr>
<td>EN 300 440 Electromagnetic compatibility and Radio spectrum Matters (ERM); Short range devices; Radio equipment to be used in the 1 GHz to 40 GHz frequency range</td>
<td></td>
</tr>
<tr>
<td>EN 300 328 Electromagnetic compatibility and Radio spectrum Matters (ERM); Wideband transmission systems</td>
<td></td>
</tr>
</tbody>
</table>

The ACMA supplier code number is N20233

3.5 Japan
D52Q and D52M models have been granted type certificate (mark numbers below). Standard applied: 2.4GHz band wide-band low-power data communication system (item 19 of Article 2 paragraph 1).

- For D52Q models: mark number R201-160147
- For D52M models: mark number R201-163171

3.6 Korea
The D52Q and D52M modules have been certificated under the Clause 2, Article 58-2 of Radio Wave Act by Ministry of Science, ICT and future Planning, Republic of Korea. The certification No’s. are:

- For D52Q models: MSIP-CRM-D23-D52Q
- For D52M models: MSIP-CRM-D23-D52M

3.7 BLUETOOTH Qualification
D52Q and D52M modules are listed as Bluetooth components (tested) on the Bluetooth SIG Qualified Design List:

- For D52Q models: Qualified Design ID 83227; Declaration ID is D030904
- For D52M models: Qualified Design ID 89214; Declaration ID is D032894

Further use of this design to create subsequent BLUETOOTH implementations can be achieved without further qualification provided that the resulting implementation has no negative material impact on the BLUETOOTH performance or functionality of the design.
4 Licensing & Conditions of Use

Products incorporating D52 series modules wishing to make use of the certifications outlined in section 3 must guarantee that they are using an approved ANT and or Bluetooth low energy SoftDevice and have entered into a D52 Series Module Distribution Agreement with Garmin Canada. Section 4.1 outlines the conditions of use for D52 modules (which includes the D52 Series Module Distribution Agreement), and Section 4.2 outlines where to obtain licenses for the approved SoftDevices.

4.1 Conditions of Use

The D52 Series of modules have been designed to support the ANT and/or Bluetooth low energy Protocols and are certified for use in many geographic regions around the globe. However, a product incorporating the D52 series module may carry the certification IDs of the module only if it complies with the restrictions and terms, including use of Garmin-approved software, provided in the conditions of use available at:

https://www.thisisant.com/developer/components/d52/#798_tab?components/d52/conditions-of-use

4.2 SoftDevice Licensing

ANT and Bluetooth low energy SoftDevices approved for use on the D52 Module series as referenced in section 4.1 – Conditions of Use – are licensed separately from Garmin and Nordic Semiconductor:

<table>
<thead>
<tr>
<th>SoftDevice</th>
<th>Protocol(s)</th>
<th>Licensor</th>
<th>Link</th>
</tr>
</thead>
<tbody>
<tr>
<td>S212</td>
<td>ANT</td>
<td>Garmin</td>
<td>Garmin SoftDevices</td>
</tr>
<tr>
<td>S332</td>
<td>ANT and Bluetooth low energy</td>
<td>Garmin</td>
<td>Garmin SoftDevices</td>
</tr>
<tr>
<td>S132</td>
<td>Bluetooth low energy</td>
<td>Nordic Semiconductor</td>
<td>Nordic Downloads</td>
</tr>
</tbody>
</table>

Table 8: SoftDevice Licensing and Downloads
5 Electrical Specifications

5.1 Recommended Operating Conditions

<table>
<thead>
<tr>
<th>Parameter</th>
<th>Min</th>
<th>Max</th>
<th>Unit</th>
</tr>
</thead>
<tbody>
<tr>
<td>Operating ambient temperature</td>
<td>-40</td>
<td>+85</td>
<td>°C</td>
</tr>
<tr>
<td>range, T&lt;sub&gt;A&lt;/sub&gt;</td>
<td></td>
<td></td>
<td></td>
</tr>
<tr>
<td>Operating supply voltage</td>
<td>1.71</td>
<td>3.6</td>
<td>V</td>
</tr>
</tbody>
</table>

Table 9: Recommended Operating Conditions

5.2 Absolute Maximum Ratings

<table>
<thead>
<tr>
<th>Parameter</th>
<th>Test Conditions</th>
<th>Min</th>
<th>Max</th>
<th>Unit</th>
</tr>
</thead>
<tbody>
<tr>
<td>Supply Voltage (VCC)</td>
<td>-0.3</td>
<td>3.9</td>
<td>V</td>
<td></td>
</tr>
<tr>
<td>V&lt;sub&gt;I/O&lt;/sub&gt;, VCC ≤ 3.6V</td>
<td>-0.3</td>
<td>VCC+0.3</td>
<td>V</td>
<td></td>
</tr>
<tr>
<td>V&lt;sub&gt;I/O&lt;/sub&gt;, VCC &gt; 3.6V</td>
<td>-0.3</td>
<td>3.9</td>
<td>V</td>
<td></td>
</tr>
<tr>
<td>Storage temperature range</td>
<td>-40</td>
<td>85</td>
<td>°C</td>
<td></td>
</tr>
<tr>
<td>ESD</td>
<td>All pads, according to human-body</td>
<td>4</td>
<td>(D52Q)</td>
<td>kV</td>
</tr>
<tr>
<td></td>
<td>model, JEDEC STD 22, method A114</td>
<td>2</td>
<td>(D52M)</td>
<td></td>
</tr>
<tr>
<td></td>
<td>According to charged-device model,</td>
<td>1000</td>
<td>(D52Q)</td>
<td></td>
</tr>
<tr>
<td></td>
<td>JEDEC STD 22, method C101</td>
<td>500</td>
<td>(D52M)</td>
<td></td>
</tr>
</tbody>
</table>

Table 10: Absolute Maximum Ratings

Stresses beyond those listed under Absolute Maximum Ratings may cause permanent damage to the device. These are stress ratings only and functional operation of the device at these or any other conditions beyond those indicated under Recommended Operating Conditions are not implied. Exposure to absolute-maximum-rated conditions for extended periods may affect device reliability.

5.3 Electrical Specifications

Please refer to the nRF52832 Product Specification by Nordic Semiconductor.

5.4 Radio Operation Specifications

<table>
<thead>
<tr>
<th>nRF52832 Output Setting (dBm)</th>
<th>Typical Peak Radio Current (mA)*</th>
</tr>
</thead>
<tbody>
<tr>
<td>0 (DCDC, 3V)</td>
<td>5.3</td>
</tr>
<tr>
<td>0 (LDO, 3V)</td>
<td>11.6</td>
</tr>
<tr>
<td>+4 (DCDC, 3V)</td>
<td>7.5</td>
</tr>
<tr>
<td>+4 (LDO, 3V)</td>
<td>16.6</td>
</tr>
</tbody>
</table>

Table 11: Current Consumption of Radio Operation

* For additional information regarding radio current please refer to the nRF52832 product specification from Nordic Semiconductor
The following typical radiation pattern for D52Q (M4) models was recorded in an anechoic chamber at 2440MHz and 0dBm output following the recommended mounting guide.

Figure 17: D52Q M4 Module Typical Antenna Gain (dBi)

To understand and properly use the radiation pattern for your design, please refer to the application note: Interpreting RF Radiation Patterns.
The following typical radiation pattern for D52Q (M4) models was recorded in an anechoic chamber at 2440MHz and 0dBm output following the recommended mounting guide.

Figure 18: D52M M8 Module Typical Antenna Gain (dBi)
6 Mechanical Drawings

Figure 19: D52Q M4 Mechanical Drawing
Figure 20: D52M M8 Mechanical Drawing
7 Support


7.1 ANT Forum

Customers are encouraged to participate in the ANT forum moderated by the application engineering team of Garmin Canada for any engineering discussions. Joining the ANT forum is free and open at http://www.thisisant.com/forum.

7.2 Technical References

Documents

1. nRF52832 Product Specification, Nordic Semiconductor
2. nRF52 Series Compatibility Matrix, Nordic Semiconductor Infocenter
3. nRF52832 Objective Product Specification, Nordic Semiconductor
4. nRF52832 S212 SoftDevice Specification, Dynastream Innovations
5. nRF52832 S332 SoftDevice Specification, Dynastream Innovations
6. nRF52832 S132 SoftDevice Specification, Nordic Semiconductor
7. nRF52 Development Kit Documentation, Nordic Semiconductor Infocenter
8. ANT SoC Module Starter Kit User Manual, Dynastream Innovations
9. ANT Message Protocol and Usage, Dynastream Innovations
10. Interfacing with ANT General Purpose Chipsets and Modules, Dynastream Innovations
11. ANT Technical Note – Migrating an ANT nRF51 Project to nRF52
12. Application Note: Interpreting RF Radiation Patterns, Dynastream Innovations

Software

1. S212 nRF52832 SoftDevice, Dynastream Innovations
2. S332 nRF52832 SoftDevice, Dynastream Innovations
3. S132 nRF52832 SoftDevice, Nordic Semiconductor
4. nRF5 SDK, Nordic Semiconductor
5. ANT Network Processor Application Code
6. ANTwareII – a system testing and debugging tool, Dynastream Innovations
7. ObservANT – an ANT debugging tool, Dynastream Innovations

Design models

1. D52Q Altium library, Dynastream Innovations
2. D52Q module STEP model, Dynastream Innovations
3. D52M Altium library, Dynastream Innovations
4. D52M module STEP model, Dynastream Innovations

The above documents and software are available at www.thisisant.com and/or www.nordicsemi.com / infocenter.nordicsemi.com. User registration may be required.

7.3 ANT Developer’s Zone

ANT development software tools, application notes, reference designs and other public resources are found in the ANT Developer’s Zone at http://www.thisisant.com/developer.

To begin development with the ANT+ interoperability, please become an ANT+ Adopter or ANT+ Alliance member to obtain the access to the ANT+ Adopter Zone. ANT+ documents and design tools contained in the ANT+ Adopter zone include the ANT+ Device Profiles, ANT-FS specification, ANT software (PC/Mac) libraries with source code, simulator tools (SimulANT+), ObservANT, embedded reference designs with source code, and more.
7.4 ANT and ANT+ Social Media

Further information, resources and news about ANT can be found in social media:

- YouTube: [http://www.youtube.com/user/ANTAlliance](http://www.youtube.com/user/ANTAlliance)
- Twitter: [http://twitter.com/ANTPlus](http://twitter.com/ANTPlus)
- Facebook: [https://www.facebook.com/thisisant](https://www.facebook.com/thisisant)
- LinkedIn: [http://www.linkedin.com/groups?gid=1379137](http://www.linkedin.com/groups?gid=1379137)
Appendix A – Using the ANT Network Processor Configuration

D52 modules are preloaded with a default ANT network processor reference code image in the application code space of the nRF52832. Using this configuration is similar to ANT legacy ICs or modules, as illustrated in the diagram below. This reference code is available upon request.

![Diagram of ANT Network Processor Configuration](image)

**Figure 21: Using ANT Network Processor**

With this configuration, the D52Q M4 model is basically drop-in compatible with ANT11TS33M4/5IB, ANTAP281M4/5IB, ANTC782M4/5IB modules, N5150M4CD, N550M4CC and N548M4CB modules (see 2.3: Pin-outs for complete details). Please note that C7 and AP2 modules supported bit synchronous, while the D52 Module Series do not. Byte synchronous and asynchronous are supported by the D52 Module Series network processor application.

For information regarding ANT network processor serial interfaces, please refer to document "Interfacing with ANT General Purpose Chipsets and Modules".

### Pin Assignments in the ANT Network Processor Configuration

In the pre-loaded ANT network processor configuration, specific functions are assigned to module pins. Details are summarized below (Table 12 for D52Q pin assignments, Table 13 for D52M pin assignments). **Note:** For the D52Q Network Processor configuration, pins P201 – P217 are not used (no connection):

<table>
<thead>
<tr>
<th>D52Q M4 Pin</th>
<th>D52Q M6 Molex Connector</th>
<th>nRF52832 Pin Name</th>
<th>ANT Network Processor Pin Assignments</th>
</tr>
</thead>
<tbody>
<tr>
<td></td>
<td></td>
<td></td>
<td>Pin Name</td>
</tr>
<tr>
<td>H202</td>
<td>10</td>
<td>P021/nRESET</td>
<td>nRST</td>
</tr>
<tr>
<td>H203</td>
<td>1</td>
<td>VCC</td>
<td>VCC</td>
</tr>
<tr>
<td>H204</td>
<td>19</td>
<td>VSS</td>
<td>GND</td>
</tr>
<tr>
<td>H206</td>
<td>17</td>
<td>P006</td>
<td>nSUSPEND / nSRDY</td>
</tr>
<tr>
<td></td>
<td></td>
<td></td>
<td></td>
</tr>
<tr>
<td>H207</td>
<td>15</td>
<td>P007</td>
<td>SLEEP / nMRDY</td>
</tr>
<tr>
<td></td>
<td></td>
<td></td>
<td></td>
</tr>
<tr>
<td>H209</td>
<td>11</td>
<td>P008</td>
<td>PORTSEL</td>
</tr>
<tr>
<td>H210</td>
<td>7</td>
<td>P011</td>
<td>BR2/SCLK</td>
</tr>
<tr>
<td></td>
<td></td>
<td></td>
<td></td>
</tr>
<tr>
<td>H211</td>
<td>4</td>
<td>P017</td>
<td>TXD0 / SOUT</td>
</tr>
<tr>
<td></td>
<td></td>
<td></td>
<td></td>
</tr>
<tr>
<td>H212</td>
<td>3</td>
<td>P016</td>
<td>RXD0 / SIN</td>
</tr>
<tr>
<td></td>
<td></td>
<td></td>
<td></td>
</tr>
<tr>
<td>H213</td>
<td>5</td>
<td>P015</td>
<td>BR1</td>
</tr>
<tr>
<td></td>
<td></td>
<td></td>
<td></td>
</tr>
<tr>
<td>H214</td>
<td>9</td>
<td>P014</td>
<td>BR3 / SPD_SEL</td>
</tr>
<tr>
<td></td>
<td></td>
<td></td>
<td></td>
</tr>
<tr>
<td>H217</td>
<td>2</td>
<td>P012</td>
<td>RTS/SEN</td>
</tr>
<tr>
<td></td>
<td></td>
<td></td>
<td></td>
</tr>
</tbody>
</table>

**Table 12: Pin Assignments in ANT Network Processor Configuration on D52Q models**
Asynchronous Serial Mode

The baud rate of the asynchronous communication is controlled by the speed select signals BR1, BR2 and BR3. Please refer to the table below.

<table>
<thead>
<tr>
<th>BR3</th>
<th>BR2</th>
<th>BR1</th>
<th>Baud Rate</th>
</tr>
</thead>
<tbody>
<tr>
<td>1</td>
<td>1</td>
<td>0</td>
<td>2400</td>
</tr>
<tr>
<td>0</td>
<td>0</td>
<td>0</td>
<td>4800</td>
</tr>
<tr>
<td>1</td>
<td>0</td>
<td>1</td>
<td>9600</td>
</tr>
<tr>
<td>0</td>
<td>1</td>
<td>0</td>
<td>19200</td>
</tr>
<tr>
<td>0</td>
<td>0</td>
<td>1</td>
<td>38400</td>
</tr>
<tr>
<td>0</td>
<td>1</td>
<td>1</td>
<td>57600</td>
</tr>
<tr>
<td>1</td>
<td>1</td>
<td>1</td>
<td>57600</td>
</tr>
<tr>
<td>1</td>
<td>0</td>
<td>0</td>
<td>115200</td>
</tr>
</tbody>
</table>

Table 14: Asynchronous Serial Mode Baud Rate Select
Asynchronous Serial Mode Connection Example

Figure 22: D52Q M4 ANT NP Configuration Async Serial Connection

Notes:

- Module RXD and TXD connected directly to hardware USART of microcontroller.
- Switches on baud rate selection pins (BR1, BR2 and BR3) are for ease of use only. They can be connected directly to the logic level of interest.
- RTS is hardware controlled on the D52 module and follows the RTS behaviour described in the nRF52 Series Reference Manual. In addition, RTS is toggled by the network processor application during message processing. If HW flow control is not available on MCU, the software implemented flow control must be able to manage serial communication flow control on a per byte level.
Byte Synchronous Serial Mode

The clock speed of the byte-Sync mode can be set to either 500KHz or 4MHz by setting BR3. Please refer to the table below.

<table>
<thead>
<tr>
<th>SPD-SEL</th>
<th>Byte-Sync Speed</th>
</tr>
</thead>
<tbody>
<tr>
<td>0</td>
<td>500KHz</td>
</tr>
<tr>
<td>1</td>
<td>4MHz</td>
</tr>
</tbody>
</table>

Table 15: Byte-Sync Mode Speed Selection

Byte Synchronous Mode Connection Example

![Byte Synchronous Mode Connection Example Diagram]

Figure 23: D52Q M4 ANT NP Configuration Byte Sync Connection

Notes:

- Module SOUT, SIN, and SCLK connected directly to hardware USART of microcontroller.
- SEN needs to be on an interrupt capable I/O pin on the microcontroller. (Interrupt pins located on Port 1&2 on the MSP430F1232)

DC/DC Configuration

The pre-programmed ANT Network Processor Application provides a method of configuring the DC/DC converter on the module via Serial Command. This allows modules featuring compatible ICs to use the DC/DC features of the nRF52832.
Please refer to the nRF52832 Product Specification for details on the DC/DC. DC/DC should only be used on appropriate modules.

The following serial command message has been defined in the ANT network processor code. A host microcontroller can issue this command to the ANT network processor application to configure the DC/DC operation on the D52Q module.

<table>
<thead>
<tr>
<th>Sync</th>
<th>Length</th>
<th>MsgID</th>
<th>Payload</th>
<th>Chksum</th>
</tr>
</thead>
<tbody>
<tr>
<td>0x02</td>
<td>0xE4</td>
<td>0x01</td>
<td>0x00 – DC/DC Disable</td>
<td></td>
</tr>
<tr>
<td></td>
<td></td>
<td></td>
<td>0x01 – DC/DC Enable</td>
<td></td>
</tr>
</tbody>
</table>

Table 16: ANT DC/DC Configuration Command

After issuing the command, the following response is generated.

<table>
<thead>
<tr>
<th>Sync</th>
<th>Length</th>
<th>MsgID</th>
<th>Response</th>
<th>Chksum</th>
</tr>
</thead>
<tbody>
<tr>
<td>0x04</td>
<td>0xE0</td>
<td>0x00</td>
<td>0xE4 0x01 0x00</td>
<td></td>
</tr>
</tbody>
</table>

Table 17: ANT DC/DC Configuration Response

Note: Sync and Chksum values are defined in the document "Interfacing with ANT General Purpose Chipsets and Modules".

A response of 0x00 indicates successful configuration of the DC/DC.

**Appendix B – D52 Module Series Pre-Loaded Software Versions**

<table>
<thead>
<tr>
<th>D52 Series Model</th>
<th>Tracking Code(^1)</th>
<th>S212 ANT SoftDevice version from Garmin</th>
<th>ANT Network Processor Application Version</th>
</tr>
</thead>
<tbody>
<tr>
<td>D52Q D2M4IA, D52Q D2M4IA-A</td>
<td>YW2, YWA</td>
<td>V 1.0.2</td>
<td>D52Q V 1.0.0</td>
</tr>
<tr>
<td>D52Q D2M4IA, D52Q D2M4IA-A</td>
<td>YWB</td>
<td>V 2.0.0</td>
<td>D52Q V 2.0.0</td>
</tr>
<tr>
<td>D52M D2M8IA</td>
<td>YW4, YWB, YWC</td>
<td>V 4.0.5</td>
<td>D52M V 1.0.0</td>
</tr>
<tr>
<td>D52Q PMM4IA, D52Q PMM4IA-A</td>
<td>YWA</td>
<td>V 4.0.5</td>
<td>D52Q V 2.0.0</td>
</tr>
<tr>
<td>D52Q PMM4IA, D52Q PMM4IA-A</td>
<td>YWA</td>
<td>V 4.0.5</td>
<td>D52M V 1.0.0</td>
</tr>
<tr>
<td>D52Q PMM4IA, D52Q PMM4IA-A</td>
<td>YWB</td>
<td>V 5.0.0</td>
<td>D52Q V 3.0.0</td>
</tr>
<tr>
<td>D52M PMM8IA</td>
<td>YWB</td>
<td>V 5.0.0</td>
<td>D52M V 2.0.0</td>
</tr>
</tbody>
</table>

Table 18: D52 Preloaded Software Versions

\(^1\) YW refers to the year and week of manufacture, the third character represents the revision. See section 1.2 - Production Tracking Code for more information.